



Microsemi Corporation

April 22, 2015

Product/Process Change Notification No: PCN1501

Change Classification: Minor

Subject: Change in ordering part number for SmartFusion2 Advanced Development Kit (M2S15-ADV-DEV-KIT-ES) and change in SmartFusion2 device on board

Description of Change: Microsemi announces the change in ordering part number for the SmartFusion2 Advanced Development Kit. Earlier, the kit was available with ordering part number M2S150-ADV-DEV-KIT-ES. This kit had engineering sample silicon M2S150T-1FCG1152ES.

The new ordering part number for this kit is M2S150-ADV-DEV-KIT. This kit comes with the production silicon M2S150TS-1FCG1152. This device also supports advanced data security features.

Previous Part Number	New Part Number
M2S150-ADV-DEV-KIT-ES	M2S150-ADV-DEV-KIT

Note: Microsemi will not offer any return material authorization (RMA) for old kits that have ES silicon. If you need a kit with production silicon, please order a new kit.

Reason for Change: Production version of the silicon is now available.

Application Impact: None

Method of Identifying Changed Product: Part marking on SmartFusion2 device will not have ES anymore.

Products Affected by this Change: SmartFusion2 Advanced Development Kit

Production Shipment Schedule: Now

Qualification Data: N/A

Samples Availability: N/A



Contact Information:

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If you have any questions related to this topic, contact Microsemi's Technical Support at:

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Regards,

Microsemi Corporation

Any projected dates in this PCN are based on the most current product information at the time this PCN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

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